



ACE2304B

N-Channel Enhancement Mode MOSFET

Description

The ACE2304BBM+ uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.

Features

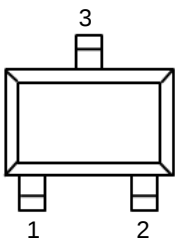
- 30V/5A
- $R_{DS(ON)}=26m\Omega$ (typ.) @ $V_{GS}=10V$
- $R_{DS(ON)}=37m\Omega$ (typ.) @ $V_{GS}=4.5V$

Absolute Maximum Ratings

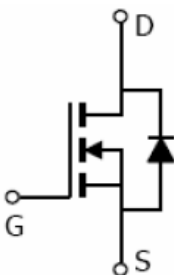
Parameter		Symbol	Max	Unit
Drain-Source Voltage		V_{DSS}	30	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current (Continuous)	$T_A=25^\circ C$	I_D	5	A
	$T_A=70^\circ C$		4.1	
Drain Current (Pulsed)		I_{DM}	20	A
Power Dissipation	$T_A=25^\circ C$	P_D	1.4	W
	$T_A=70^\circ C$		1	
Operating temperature / storage temperature		T_J/T_{STG}	-55~150	$^\circ C$

Packaging Type

SOT-23-3L



SOT-23-3L	Description	Function
1	G	Gate
2	S	Source
3	D	Drain





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Ordering information

ACE2304B XX + H

└─┘	Halogen - free
└─┘	Pb - free
└─┘	BM : SOT-23-3L

Electrical Characteristics

$T_A=25^{\circ}\text{C}$, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	30	34		V
Zero gate voltage drain current	I _{DSS}	V _{DS} =24V, V _{GS} =0V			1	μA
Gate threshold voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _{DS} =250μA	1	1.4	2	V
Gate leakage current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			100	nA
Drain-source on-state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5.8A		26	31.5	mΩ
		V _{GS} =4.5V, I _D =5A		37	44	mΩ
Forward transconductance	g _{FS}	V _{DS} =5V, I _D =5A		15		S
Diode forward voltage	V _{SD}	I _{SD} =1A, V _{GS} =0V		0.77	1.0	V
Maximum body-diode continuous current	I _S				3	A
Switching						
Total gate charge	Qg	V _{GS} =10V, V _{DS} =15V, I _D =5A		7.6	9.9	nC
Gate-source charge	Qgs			1.3	1.7	nC
Gate-drain charge	Qgd			1.7	2.2	nC
Turn-on delay time	t _{d(on)}	V _{GS} =10V, V _{DD} =15V, I _D =1A R _L =15Ω, R _G =6Ω		10.1	20.3	ns
Turn-on rise time	Tr			3.2	6.3	ns
Turn-off delay time	t _{d(off)}			22.2	44.4	ns
Turn-off fall time	Tf			3	6	ns
Dynamic						
Input capacitance	Ciss	V _{GS} =0V, V _{DS} =15V, f=1.0MHz		391		pF
Output capacitance	Coss			86.2		pF
Reverse transfer capacitance	Crss			59.4		pF
Gate resistance	Rg	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.4	2	Ω



Typical Performance Characteristics

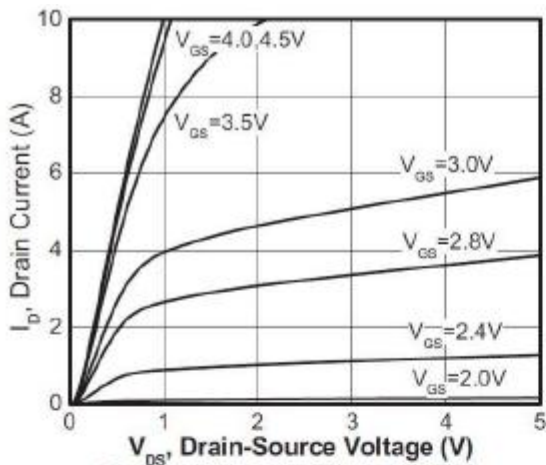


Figure 1. Output Characteristics

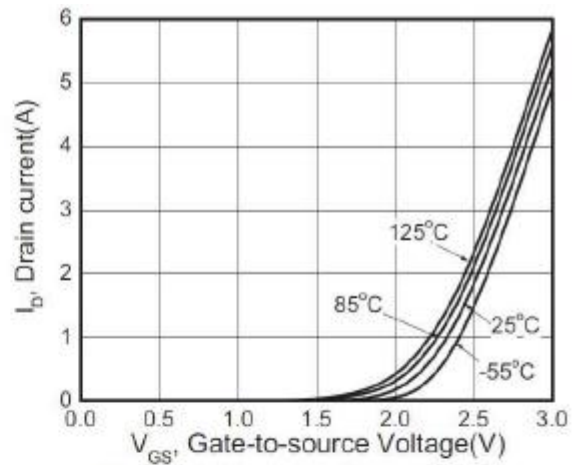


Figure 2. Transfer Characteristics

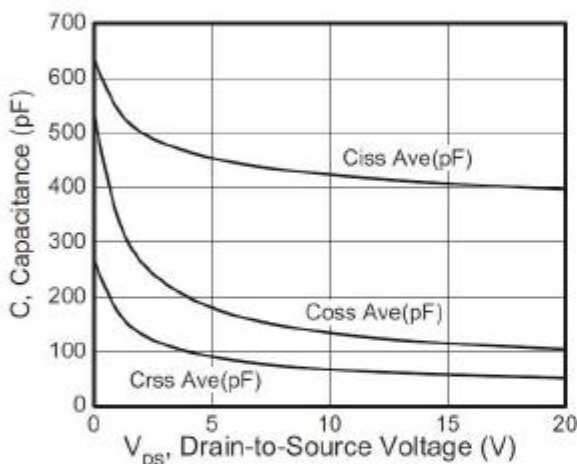


Figure 3. Capacitance

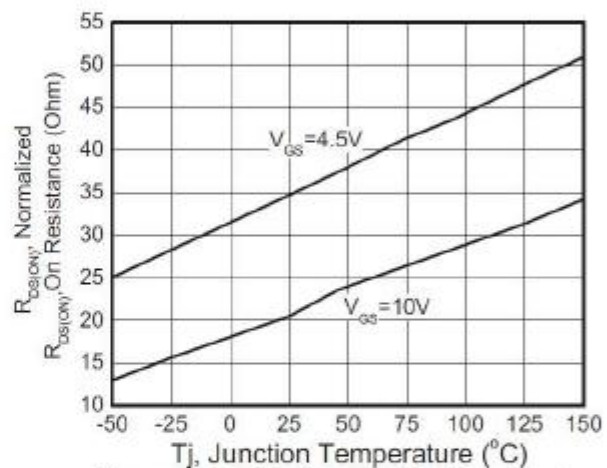


Figure 4. On Resistance Vs. Temperature

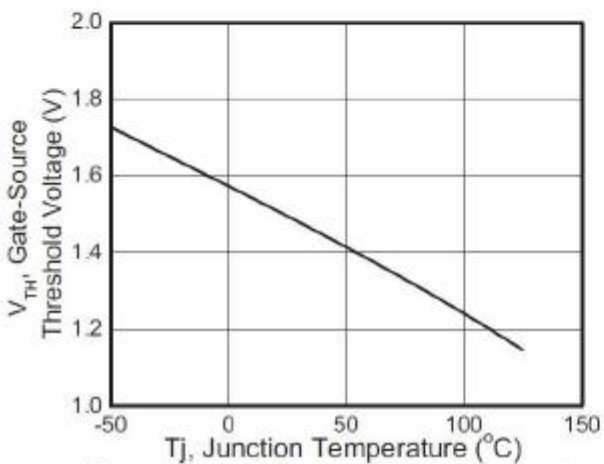


Figure 5. Gate Threshold Vs. Temperature

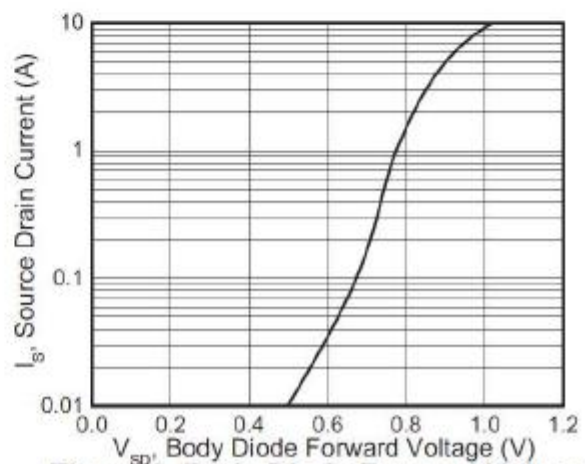


Figure 6. Body Diode Forward Voltage Vs. Source Current

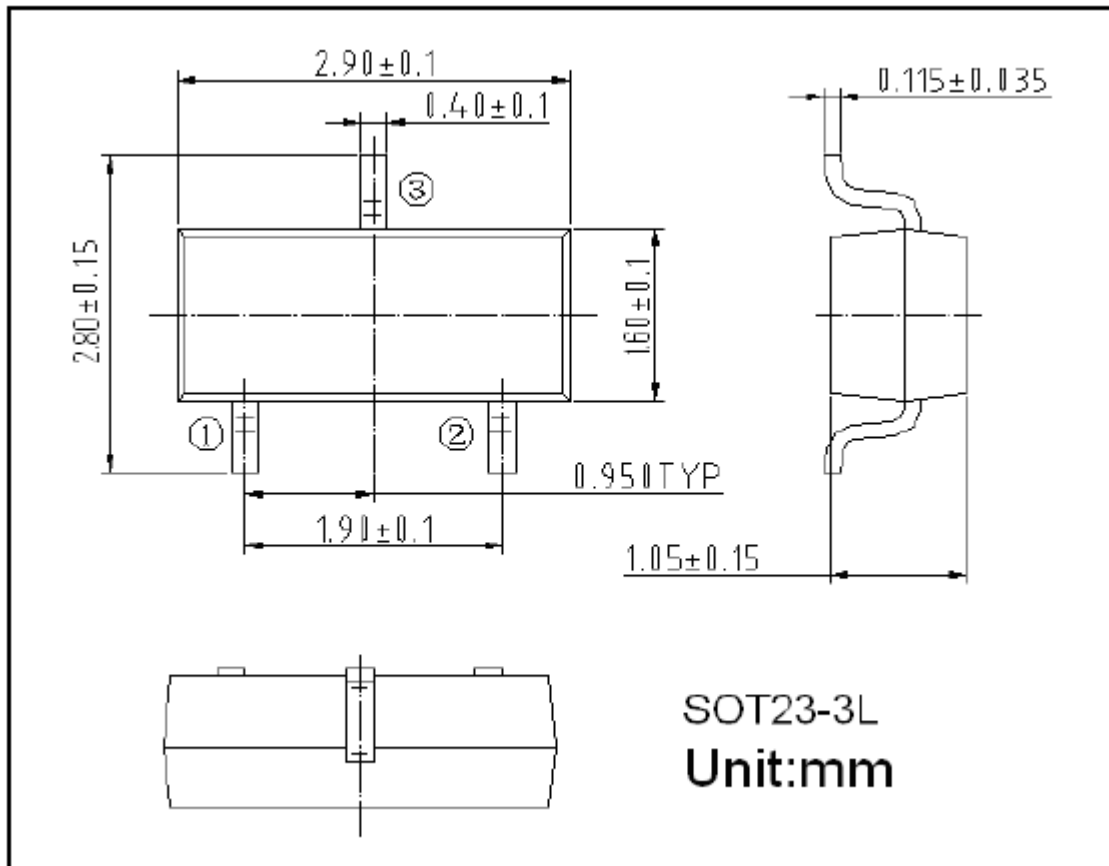


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Packing Information

SOT-23-3L





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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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